



Final Product Change Notification

201408019F01

Issue Date: 26-Aug-2014

Effective Date: 08-Dec-2014

Here's your personalized quality information concerning products Digi-Key purchased from NXP. For detailed information we invite you to [view this notification online](#)



QUALITY

Management Summary

NXP is going to setup a 2nd source for Final Test for products CLRC663, MFRC631, MFRC630, SLRC610, OM9663 and OM9628.

Change Category

- | | | | |
|--|---|---|--|
| <input type="checkbox"/> Wafer Fab process | <input type="checkbox"/> Assembly Process | <input type="checkbox"/> Product Marking | <input type="checkbox"/> Design |
| <input type="checkbox"/> Wafer Fab materials | <input type="checkbox"/> Assembly Materials | <input type="checkbox"/> Electrical spec./Test coverage | <input type="checkbox"/> Mechanical Specification |
| <input type="checkbox"/> Wafer Fab location | <input type="checkbox"/> Assembly Location | <input checked="" type="checkbox"/> Test Location | <input type="checkbox"/> Packing/Shipping/Labeling |

Additional Final Test location for CLRC663, MFRC631, MFRC630, SLRC610, OM9663, OM9628

Details of this Change

NXP is going to setup a 2nd source of Final Test (ASEN in Suzhou, China) in order to increase test capacity and improve flexibility for production planning.

Why do we Implement this Change

The available test capacity in current test site (APK in Kaohsiung, Taiwan) does not offer sufficient planning flexibility.

Identification of Affected Products

Product identification does not change
Only NXP internal tracability.

Product Availability

Sample Information

Samples are available upon request

Production

Planned first shipment 08-Dec-2014

Impact

no impact to the product's functionality anticipated.

No impact to the product's functionality anticipated. Performed Measurement System Comparison ensures same final test quality as on existing test site.

Data Sheet Revision

No impact to existing datasheet

Disposition of Old Products

Not applicable.

Additional information

Self qualification: [view online](#)

Timing and Logistics

Your acknowledgement of this change, conform JEDEC JESD46 D, is expected till 25-Sep-2014.

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please [contact NXP "Global Quality Support Team"](#).

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

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Position Product Manager

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At NXP Semiconductors we are constantly striving to improve our product and processes to ensure they reach the highest possible Quality Standards.

Customer Focus, Passion to Win.

NXP Quality Management Team.

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